National *Semiconductor*

October 1996

LMC6035 Dual/LMC6036 Quad Low Power 2.7V Single Supply CMOS Operational Amplifiers

General Description

The LMC6035/6 is an economical, low voltage op amp capable of rail-to-rail output swing into loads of 600Ω. It allows for single supply operation and is guaranteed for 2.7V, 3V, 5V and 15V supply voltages. The 2.7 supply voltage corresponds to the End-of-Life voltage (0.9V/cell) for three NiCd or NiMH batteries in series, making the LMC6035/6 well suited for portable and rechargeable systems. It also features a well behaved decrease in its specifications at supply voltages below its guaranteed 2.7V operation. This provides a "comfort zone" for adequate operation at voltages significantly below 2.7V. Its ultra low input currents (I_{IN}) makes it well suited for low power active filter application, because it allows the use of higher resistor values and lower capacitor values. In addition, the drive capability of the LMC6035/6 gives these op amps a broad range of applications for low voltage systems.

Features (Typical Unless Otherwise Noted)

- Guaranteed 2.7V, 3V, 5V and 15V Performance
- Specified for 2 kΩ and 600Ω Loads
- Wide Operating Range   2.0V to 15.5V
- Ultra Low Input Current   20 fA
- Rail-to-Rail Output Swing
  @ 600Ω   200 mV from either rail at 2.7V
  @ 100 kΩ   5 mV from either rail at 2.7V
- High Voltage Gain   126dB
- Low Offset Voltage Drift   2.3 μV/°C
- Wide Input Common Mode Voltage Range   2.4V at 2.7V
- Low Distortion   0.01% at 10 kHz
- High Level ESD Protection
  Human Body Model   3000V
  Machine Model   350V

Applications

- Filters
- High Impedance Buffer or Preamplifier
- Battery Powered Electronics
- Medical Instrumentation

Connection Diagrams

8-Pin SO/MSOP

TL/H/12830–1

Top View

14-Pin SO

TL/H/12830–2

Top View
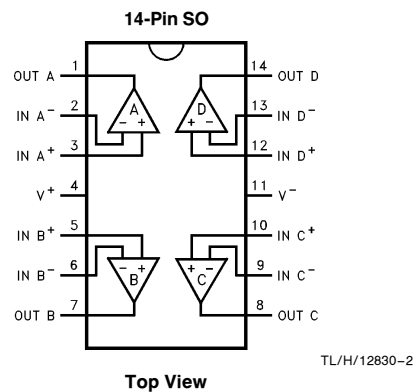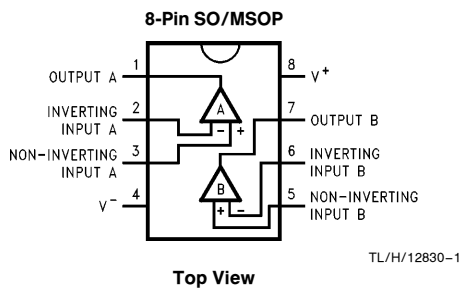
Ordering Information

Package	Temperature Range Industrial −40°C to +85°C	Transport Media	NSC Drawing
8-pin Small Outline (SO)	LMC6035IM	Rails	M8A
	LMC6035IMX	Tape and Reel	
8-pin Mini Small Outline (MSOP)	LMC6035IMM	Rails	MA08D
	LMC6035IMMX	Tape and Reel	
14-pin Small Outline (SO)	LMC6036IM	Rails	M14A
	LMC6036IMX	Tape and Reel	

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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

ESD Tolerance (Note 2)	
Human Body Model	3000V
Machine Model	350V
Differential Input Voltage	± Supply Voltage
Supply Voltage ($V^+ - V^-$)	16V
Output Short Circuit to V^+	(Note 8)
Output Short Circuit to V^-	(Note 3)
Lead Temperature (soldering, 10 sec.)	260°C
Current at Output Pin	± 18 mA
Current at Input Pin	± 5 mA
Current at Power Supply Pin	35 mA
Storage Temperature Range	−65°C to +150°C
Junction Temperature (Note 4)	150°C

Operating Ratings (Note 1)

Supply Voltage	2.0V to 15.5V
Temperature Range	
LMC6035I and LMC6036I	−40°C ± T_J ± +85°C
Thermal Resistance (θ_{JA})	
MSOP, 8-pin Mini Surface Mount	230°C/W
M Package, 8-pin Surface Mount	175°C/W
M Package, 14-pin Surface Mount	127°C/W

DC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for T_J = 25°C, V^+ = 2.7V, V^- = 0V, V_{CM} = 1.0V, V_O = 1.35V and R_L > 1 MΩ. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Typ (Note 5)	LMC6035I LMC6036I Limit (Note 6)	Units
V_{OS}	Input Offset Voltage		0.5	5 **6**	mV max
TCV_{OS}	Input Offset Voltage Average Drift		2.3		μV/°C
I_{IN}	Input Current	(Note 11)	0.02	**90**	pA max
I_{OS}	Input Offset Current	(Note 11)	0.01	**45**	pA max
R_{IN}	Input Resistance		> 10		Tera Ω
CMRR	Common Mode Rejection Ratio	0.7V ≤ V_{CM} ≤ 12.7V V^+ = 15V	96	63 **60**	dB min
+PSRR	Positive Power Supply Rejection Ratio	5V ≤ V^+ ≤ 15V, V_O = 2.5V	93	63 **60**	dB min
−PSRR	Negative Power Supply Rejection Ratio	0V ≤ V^- ≤ −10V V_O = 2.5V, V^+ = 5V	97	74 **70**	dB min
V_{CM}	Input Common-Mode Voltage Range	V^+ = 2.7V For CMRR ≥ 40 dB	−0.1	0.3 **0.5**	V max
			2.3	2.0 **1.7**	V min
		V^+ = 3V For CMRR ≥ 40 dB	−0.3	0.1 **0.3**	V max
			2.6	2.3 **2.0**	V min
		V^+ = 5V For CMRR ≥ 50 dB	−0.5	−0.2 **0.0**	V max
			4.5	4.2 **3.9**	V min
		V^+ = 15V For CMRR ≥ 50 dB	−0.5	−0.2 **0.0**	V max
			14.4	14.0 **13.7**	V min

DC Electrical Characteristics (Continued)

Unless otherwise specified, all limits guaranteed for T_J = 25°C, V^+ = 2.7V, V^- = 0V, V_{CM} = 1.0V, V_O = 1.35V and R_L > 1 MΩ. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions		Typ (Note 5)	LMC6035I LMC6036I Limit (Note 6)	Units
A_V	Large Signal Voltage Gain (Note 7)	R_L = 600Ω	Sourcing	1000	100 **75**	V/mV min
			Sinking	250	25 **20**	V/mV min
		R_L = 2 kΩ	Sourcing	2000		V/mV
			Sinking	500		V/mV
V_O	Output Swing	V^+ = 2.7V R_L = 600Ω to 1.35V		2.5	2.0 **1.8**	V min
				0.2	0.5 **0.7**	V max
		V^+ = 2.7V R_L = 2 kΩ to 1.35V		2.62	2.4 **2.2**	V min
				0.07	0.2 **0.4**	V max
		V^+ = 15V R_L = 600Ω to 7.5V		14.5	13.5 **13.0**	V min
				0.36	1.25 **1.50**	V max
		V^+ = 15V R_L = 2 kΩ to 7.5V		14.8	14.2 **13.5**	V min
				0.12	0.4 **0.5**	V max
I_O	Output Current	V_O = 0V	Sourcing	8	4 **3**	mA min
		V_O = 2.7V	Sinking	5	3 **2**	mA min
I_S	Supply Current	LMC6035 for Both Amplifiers V_O = 1.35V		0.65	1.6 **1.9**	mA max
		LMC6036 for All Four Amplifiers V_O = 1.35V		1.3	2.7 **3.0**	mA max

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AC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for $T_J = 25°C$, $V^+ = 2.7V$, $V^- = 0V$, $V_{CM} = 1.0V$, $V_O = 1.35V$ and $R_L > 1\ M\Omega$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Typ (Note 5)	Units
SR	Slew Rate	(Note 9)	1.5	$V/\mu s$
GBW	Gain Bandwidth Product	$V^+ = 15V$	1.4	MHz
θ_m	Phase Margin		48	°
G_m	Gain Margin		17	dB
	Amp-to-Amp Isolation	(Note 10)	130	dB
e_n	Input-Referred Voltage Noise	$f = 1\ kHz$ $V_{CM} = 1V$	27	$nV/\sqrt{Hz}$
i_n	Input Referred Current Noise	$f = 1\ kHz$	0.2	$fA/\sqrt{Hz}$
THD	Total Harmonic Distortion	$f = 10\ kHz$, $A_V = -10$ $R_L = 2\ k\Omega$, $V_O = 8\ V_{PP}$ $V^+ = 10V$	0.01	%

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics.

Note 2: Human body model, 1.5 kΩ in series with 100 pF.

Note 3: Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C. Output currents in excess of 30 mA over long term may adversely affect reliabilty.

Note 4: The maximum power dissipation is a function of $T_{J(max)}$, θ_{JA}, and T_A. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(max)} - T_A)/\theta_{JA}$. All numbers apply for packages soldered directly onto a PC board with no air flow.

Note 5: Typical Values represent the most likely parametric norm or one sigma value.

Note 6: All limits are guaranteed by testing or statistical analysis.

Note 7: $V^+ = 15V$, $V_{CM} = 7.5V$ and R_L connected to 7.5V. For Sourcing tests, $7.5V \leq V_O \leq 11.5V$. For Sinking tests, $3.5V \leq V_O \leq 7.5V$.

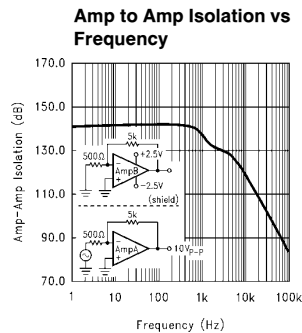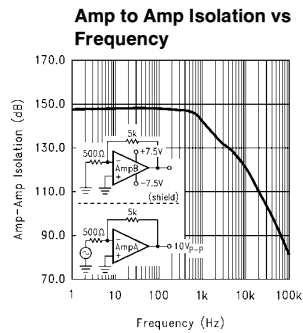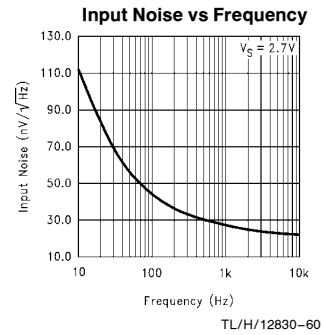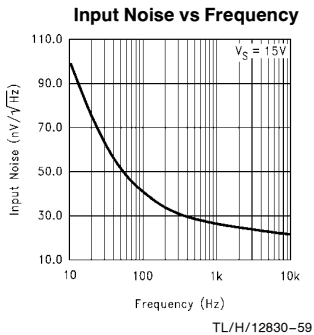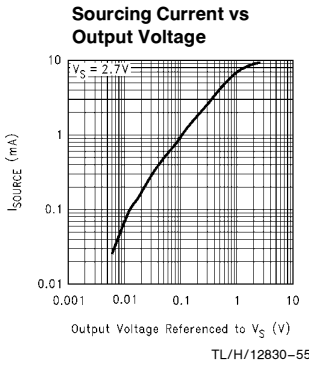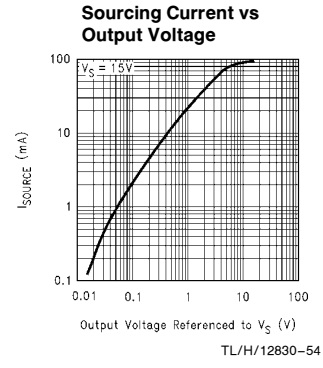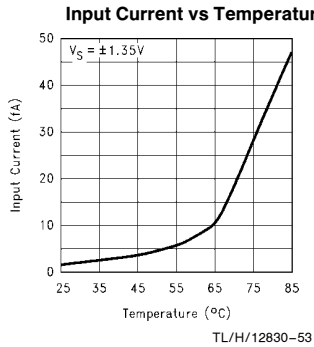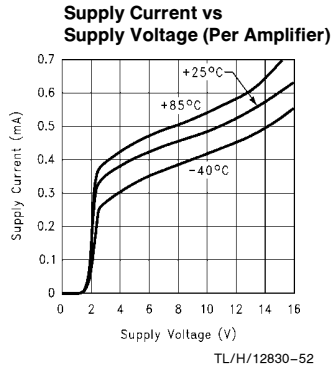**Note 8:** Do not short circuit output to V^+ when V^+ is greater than 13V or reliability will be adversely affected.

Note 9: $V^+ = 15V$. Connected as voltage follower with 10V step input. Number specified is the slower of the positive and negative slew rates.

Note 10: Input referred, $V^+ = 15V$ and $R_L = 100\ k\Omega$ connected to 7.5V. Each amp excited in turn with 1 kHz to produce $V_O = 12\ V_{PP}$.

Note 11: Guaranteed by design.
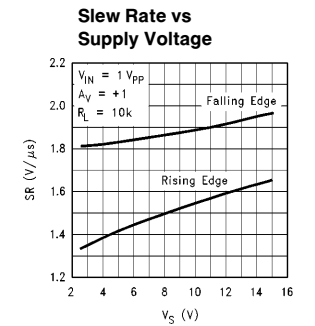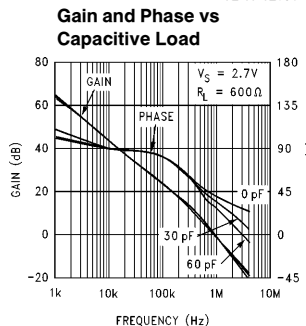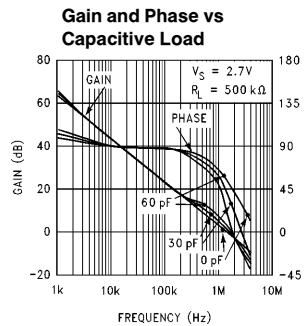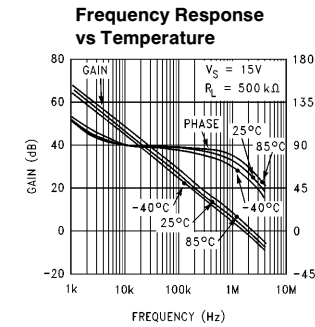
Typical Performance Characteristics Unless otherwise specified, V_S = 2.7V, single supply, T_A = 25°C

Supply Current vs Supply Voltage (Per Amplifier)
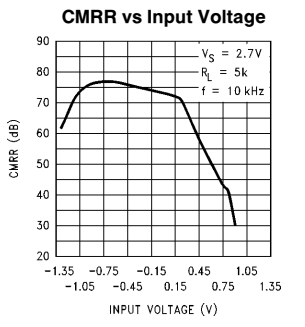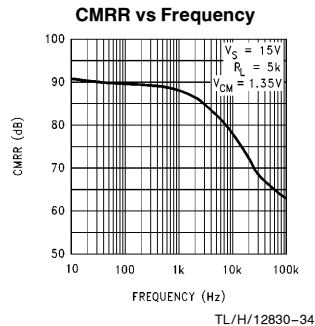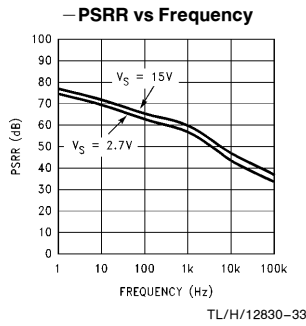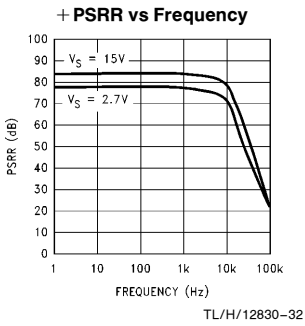

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Input Current vs Temperature

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Sourcing Current vs Output Voltage

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Sourcing Current vs Output Voltage

TL/H/12830–55

Sinking Current vs Output Voltage

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Sinking Current vs Output Voltage

TL/H/12830–57

Output Voltage Swing vs Supply Voltage

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Input Noise vs Frequency

TL/H/12830–59

Input Noise vs Frequency

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Amp to Amp Isolation vs Frequency

TL/H/12830–61

Amp to Amp Isolation vs Frequency

TL/H/12830–62

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Typical Performance Characteristics

Unless otherwise specified, V_S = 2.7V, single supply, T_A = 25°C (Continued)

+PSRR vs Frequency

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−PSRR vs Frequency

TL/H/12830–33

CMRR vs Frequency

TL/H/12830–34

CMRR vs Input Voltage

TL/H/12830–35

CMRR vs Input Voltage

TL/H/12830–36

Input Voltage vs Output Voltage

TL/H/12830–14

Input Voltage vs Output Voltage

TL/H/12830–15

Frequency Response vs Temperature

TL/H/12830–16

Frequency Response vs Temperature

TL/H/12830–17

Gain and Phase vs Capacitive Load

TL/H/12830–18

Gain and Phase vs Capacitive Load

TL/H/12830–19

Slew Rate vs Supply Voltage

TL/H/12830–37

Typical Performance Characteristics

Unless otherwise specified, V_S = 2.7V, single supply, T_A = 25°C (Continued)

Non-Inverting Large Signal Response
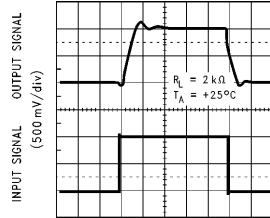

R_L = 2 kΩ
T_A = +85°C
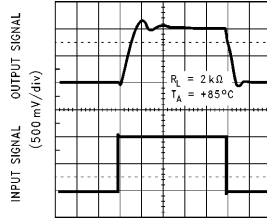
TL/H/12830–20

Non-Inverting Large Signal Response

R_L = 2 kΩ
T_A = +25°C

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Non-Inverting Large Signal Response

R_L = 2 kΩ
T_A = −40°C
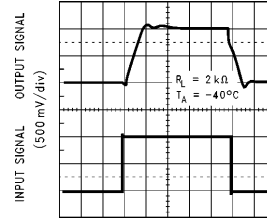
TL/H/12830–22

Non-Inverting Small Signal Response

R_L = 2 kΩ
T_A = +85°C
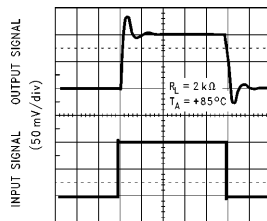
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Non-Inverting Small Signal Response

R_L = 2 kΩ
T_A = +25°C
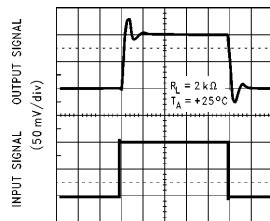
TL/H/12830–24

Non-Inverting Large Signal Response

R_L = 2 kΩ
T_A = −40°C
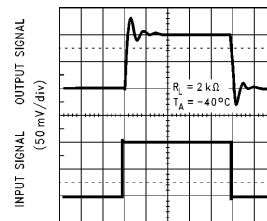
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Inverting Large Signal Response

T_A = +85°C
R_L = 2 kΩ
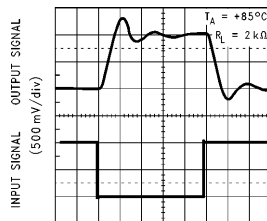
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Inverting Large Signal Response

T_A = +25°C
R_L = 2 kΩ
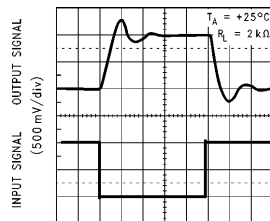
TL/H/12830–27

Inverting Large Signal Response

T_A = −40°C
R_L = 2 kΩ
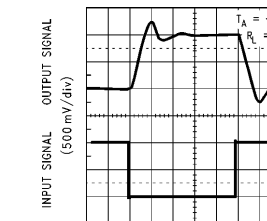
TL/H/12830–28

Inverting Small Signal Response

T_A = +85°C
R_L = 2 kΩ
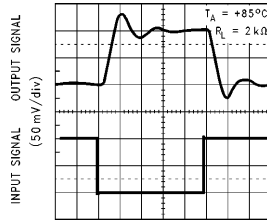
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Inverting Small Signal Response
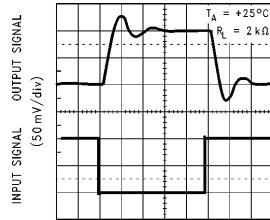
T_A = +25°C
R_L = 2 kΩ

TL/H/12830–30

Inverting Small Signal Response
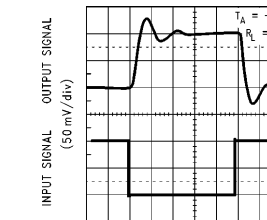
T_A = −40°C
R_L = 2 kΩ

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Typical Performance Characteristics

Unless otherwise specified, $V_S = 2.7V$, single supply, $T_A = 25°C$ (Continued)

Stability vs Capacitive Load

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Stability vs Capacitive Load

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Stability vs Capacitive Load

TL/H/12830–40

Stability vs Capacitive Load

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Stability vs Capacitive Load

TL/H/12830–42

Stability vs Capacitive Load
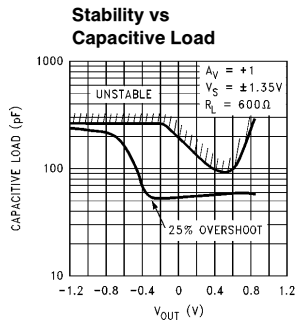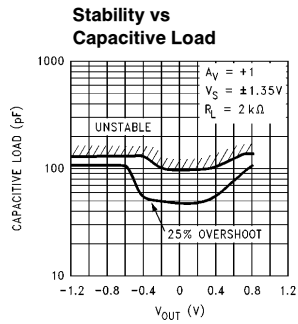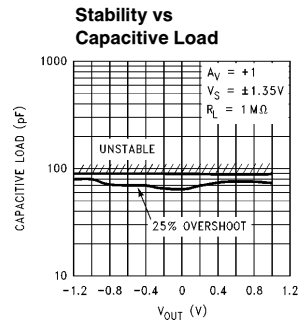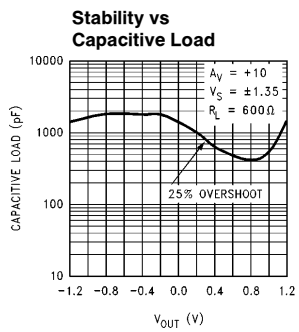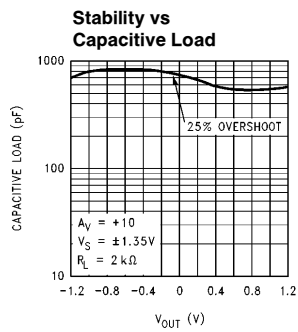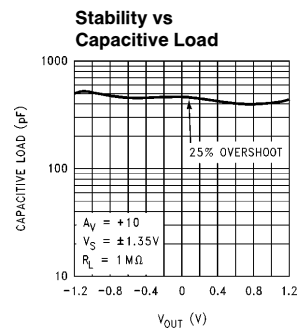
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1.0 Application Notes

1.1 BACKGROUND

The LMC6035/6 is exceptionally well suited for low voltage applications. A desirable feature that the LMC6035/6 brings to low voltage applications is its output drive capability—a hallmark for National's CMOS amplifiers. The circuit of *Figure 1* illustrates the drive capability of the LMC6035/6 at 3V of supply. It is a differential output driver for a one-to-one audio transformer, like those used for isolating ground from the telephone lines. The transformer (T1) loads the op amps with about 600Ω of AC load, at 1 kHz. Capacitor C1 functions to block DC from the low winding resistance of T1. Although the value of C1 is relatively high, its load reactance (Xc) is negligible compared to inductive reactance (X_l) of T1.
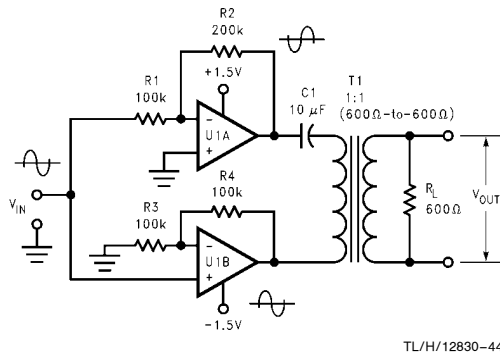

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FIGURE 1. Differential Driver

The circuit in *Figure 1* consists of one input signal and two output signals. U1A amplifies the input with an inverting gain of −2, while the U1B amplifies the input with a noninverting gain of +2. Since the two outputs are 180° out of phase with each other, the gain across the differential output is 4. As the differential output swings between the supply rails, one of the op amps sources the current to the load, while the other op amp sinks the current.

How good a CMOS op amp can sink or source a current is an important factor in determining its output swing capability. The output stage of the LMC6035/6—like many op amps—sources and sinks output current through two complementary transistors in series. This "totem pole" arrangement translates to a channel resistance (R_{dson}) at each supply rail which acts to limit the output swing. Most CMOS op amps are able to swing the outputs very close to the rails—except, however, under the difficult conditions of low supply voltage and heavy load. The LMC6035/6 exhibits exceptional output swing capability under these conditions.

The scope photos of *Figures 2* and *3* represent measurements taken directly at the output (relative to GND) of U1A, in *Figure 1*. *Figure 2* illustrates the output swing capability of the LMC6035, while *Figure 3* provides a benchmark comparison. (The benchmark op amp is another low voltage (3V) op amp manufactured by one of our reputable competitors.)
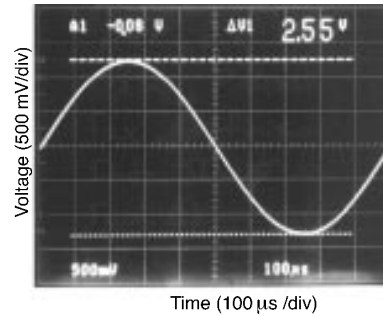

TL/H/12830–45

FIGURE 2. Output Swing Performance of the LMC6035 per the Circuit of *Figure 1*

TL/H/12830–46
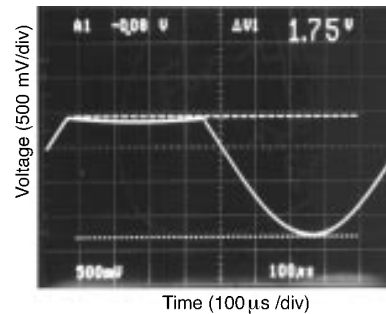
FIGURE 3. Output Swing Performance of Benchmark Op Amp per the Circuit of *Figure 1*

Notice the superior drive capability of LMC6035 when compared with the benchmark measurement—even though the benchmark op amp uses twice the supply current.

Not only does the LMC6035/6 provide excellent output swing capability at low supply voltages, it also maintains high open loop gain (A_{VOL}) with heavy loads. To illustrate this, the LMC6035 and the benchmark op amp were compared for their distortion performance in the circuit of *Figure 1*. The graph of *Figure 4* shows this comparison. The y-axis represents percent Total Harmonic Distortion (THD plus noise) across the loaded secondary of T1. The x-axis represents the input amplitude of a 1 kHz sine wave. (Note that T1 loses about 20% of the voltage to the voltage divider of R_L (600Ω) and T1's winding resistances—a performance deficiency of the transformer.)

1.0 Application Notes (Continued)

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FIGURE 4. THD+Noise Performance of LMC6035 and "Benchmark" per Circuit of *Figure 1*

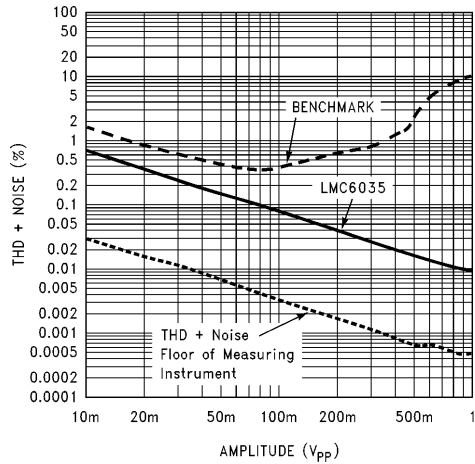*Figure 4* shows the superior distortion performance of LMC6035/6 over that of the benchmark op amp. The heavy loading of the circuit causes the A_{VOL} of the benchmark part to drop significantly which causes increased distortion.

1.2 APPLICATION CIRCUITS

1.2.1 Low-Pass Active Filter

A common application for low voltage systems would be active filters, in cordless and cellular phones for example. The ultra low input currents (I_{IN}) of the LMC6035/6 makes it well suited for low power active filter applications, because it allows the use of higher resistor values and lower capacitor values. This reduces power consumption and space.

Figure 5 shows a low pass, active filter with a Butterworth (maximally flat) frequency response. Its topology is a Sallen and Key filter with unity gain. Note the normalized component values in parenthesis which are obtainable from standard filter design handbooks. These values provide a 1 Hz cutoff frequency, but they can be easily scaled for a desired cutoff frequency (f_c). The bold component values of *Figure 5* provide a cutoff frequency of 3 kHz. An example of the scaling procedure follows *Figure 5*.
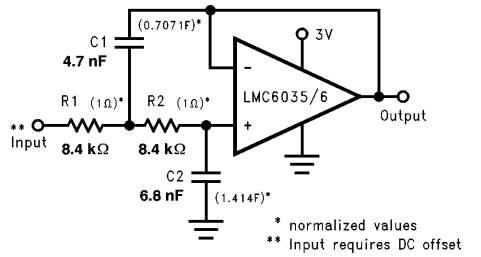

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FIGURE 5. 2-Pole, 3 kHz, Active, Sallen and Key, Lowpass Filter with Butterworth Response

1.2.1.1 Low-Pass Frequency Scaling Procedure

The actual component values represented in bold of *Figure 5* were obtained with the following scaling procedure:

a) First determine the frequency scaling factor (FSF) for the desired cutoff frequency. Choosing f_c at 3 kHz, provides the following FSF computation:

$$FSF = 2\pi \times 3 \text{ kHz}_{(\text{desired cutoff freq.})} = 18.84 \times 10^3$$

b) Then divide all of the normalized capacitor values by the FSF as follows:

$C1' = C_{(\text{Normalized})}/FSF$

$C1' = 0.707/18.84 \times 10^3 = 37.93 \times 10^{-6}$

$C2' = 1.414/18.84 \times 10^3 = 75.05 \times 10^{-6}$

(C1' and C2': prior to impedance scaling)

c) Last, choose an impedance scaling factor (Z). This Z factor can be calculated from a standard value for C2. Then Z can be used to determine the remaining component values as follows:

$Z = C2'/C2_{(\text{chosen})} = 75.05 \times 10^{-6}/\textbf{6.8 nF} = 8.4\text{k}$

$C1 = C1'/Z = 37.93 \times 10^{-6}/8.4\text{k} = 4.52 \text{ nF}$

(Standard capacitor value chosen for C1 is **4.7 nF**)

$R1 = R1_{(\text{normalized})} \times Z = 1\Omega \times 8.4\text{k} = 8.4 \text{ k}\Omega$
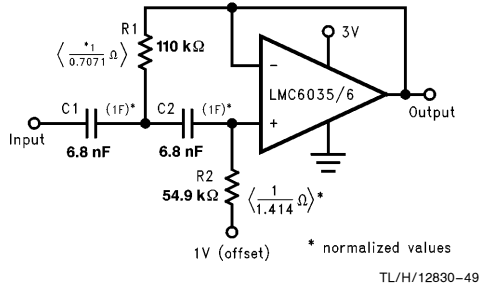
$R2 = R2_{(\text{normalized})} \times Z = 1\Omega \times 8.4\text{k} = 8.4 \text{ k}\Omega$

(Standard value chosen for R1 and R2 is **8.45 kΩ**)

1.0 Application Notes (Continued)

1.2.2 High Pass Active Filter

The previous low-pass filter circuit of *Figure 5* converts to a high-pass active filter per *Figure 6*.

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FILTER 6. 2 Pole, 300 Hz, Sallen and Key, High-Pass Filter

1.2.2.1 High-Pass Frequency Scaling Procedure

Choose a standard capacitor value and scale the impedances in the circuit according to the desired cutoff frequency (300 Hz) as follows:

$$C = C1 = C2$$

$$Z = 1 \text{ Farad}/C_{(chosen)} \times 2\pi \times (\text{desired cutoff freq.})$$

$$= 1 \text{ Farad}/\mathbf{6.8 \text{ nF}} \times 2\pi \times 300 \text{ Hz} = 78.05\text{k}$$

$R1 = Z \times R1_{(normalized)} = 78.05\text{k} \times (1/0.707) = 110.4 \text{ k}\Omega$

(Standard value chosen for R1 is **110 kΩ**)

$R2 = Z \times R2_{(normalized)} = 78.05\text{k} \times (1/1.414) = 55.2 \text{ k}\Omega$

(Standard value chosen for R1 is **54.9 kΩ**)

1.2.3 Dual Amplifier Bandpass Filter

The dual amplifier bandpass (DABP) filter features the ability to independently adjust f_c and Q. In most other bandpass topologies, the f_c and Q adjustments interact with each other. The DABP filter also offers both low sensitivity to component values and high Qs. The following application of *Figure 7*, provides a 1 kHz center frequency and a Q of 100.
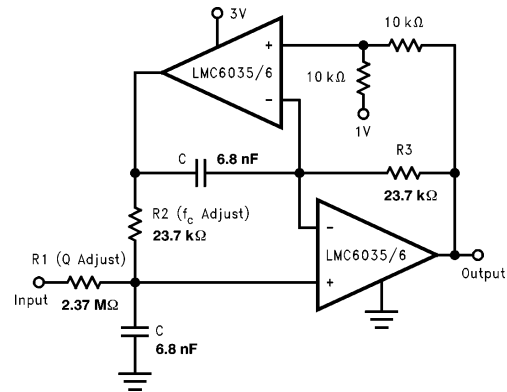

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FIGURE 7. 2 Pole, 1 kHz Active, Bandpass Filter

1.2.3.1 DABP Component Selection Procedure

Component selection for the DABP filter is performed as follows:

a) First choose a center frequency (f_c). *Figure 7* represents component values that were obtained from the following computation for a center frequency of 1 kHz.

$$R2 = R3 = 1/(2\pi f_c C)$$

Given: $f_c = 1$ kHz and $C_{(chosen)} = \mathbf{6.8 \text{ nF}}$

$$R2 = R3 = 1/(2\pi \times 3 \text{ kHz} \times 6.8 \text{ nF}) = 23.4 \text{ k}\Omega$$

(Chosen standard value is **23.7 kΩ**)

b) Then compute R1 for a desired Q (f_c/BW) as follows:

$$R1 = Q \times R2.$$

Choosing a Q of 100,

$$R1 = 100 \times 23.7 \text{ k}\Omega = \mathbf{2.37 \text{ M}\Omega.}$$

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Application Notes (Continued)

1.3 PRINTED-CIRCUIT-BOARD LAYOUT FOR HIGH-IMPEDANCE WORK

It is generally recognized that any circuit which must operate with < 1000 pA of leakage current requires special layout of the PC board. If one wishes to take advantage of the ultra-low bias current of the LMC6035/6, typically < 0.04 pA, it is essential to have an excellent layout. Fortunately, the techniques for obtaining low leakages are quite simple. First, the user must not ignore the surface leakage of the PC board, even though it may at times appear acceptably low. Under conditions of high humidity, dust or contamination, the surface leakage will be appreciable.

To minimize the effect of any surface leakage, lay out a ring of foil completely surrounding the LMC6035 or LMC6036 inputs and the terminals of capacitors, diodes, conductors, resistors, relay terminals, etc. connected to the op amp's inputs. See *Figure 8*. To have a significant effect, guard rings should be placed on both the top and bottom of the PC board. This PC foil must then be connected to a voltage which is at the same voltage as the amplifier inputs, since no leakage current can flow between two points at the same potential. For example, a PC board trace-to-pad resistance of $10^{12}\Omega$, which is normally considered a very large resistance, could leak 5 pA if the trace were a 5V bus adjacent to the pad of an input. This would cause a 100 times degradation from the amplifiers actual performance. However, if a guard ring is held within 5 mV of the inputs, then even a resistance of $10^{11}\Omega$ would cause only 0.05 pA of leakage current, or perhaps a minor (2:1) degradation of the amplifier's performance. See *Figures 9a, 9b, 9c* for typical connections of guard rings for standard op amp configurations. If both inputs are active and at high impedance, the guard can be tied to ground and still provide some protection; see *Figure 9d*.

(a) Inverting Amplifier

TL/H/12830–8

(b) Non-Inverting Amplifier

TL/H/12830–9

(c) Follower

TL/H/12830–10

(d) Howland Current Pump

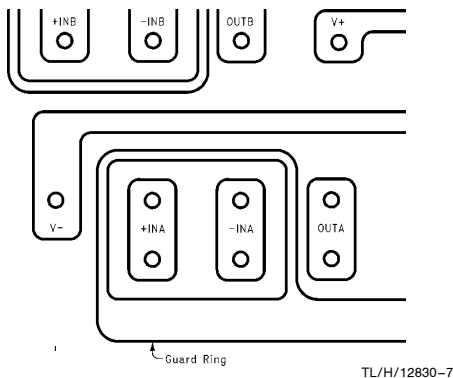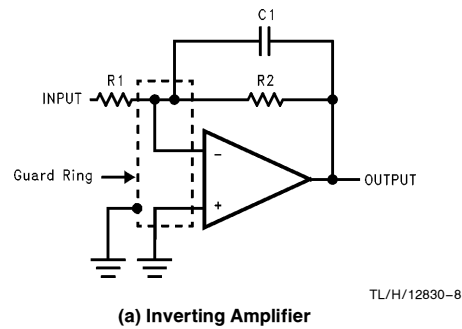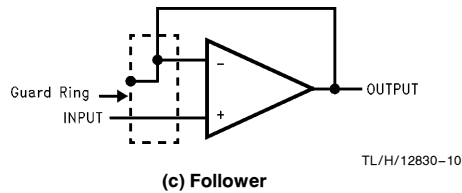TL/H/12830–11

FIGURE 9. Guard Ring Connections

TL/H/12830–7

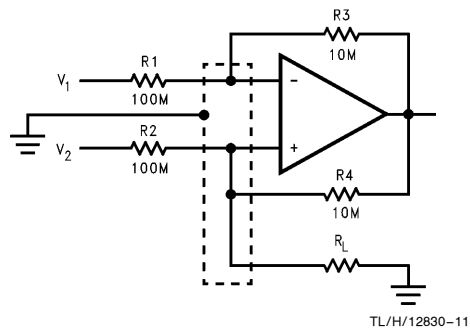**FIGURE 8. Example, using the LMC6036 of Guard Ring in P.C. Board Layout**

Application Notes (Continued)

1.3.1 CAPACITIVE LOAD TOLERANCE

Like many other op amps, the LMC6035/6 may oscillate when its applied load appears capacitive. The threshold of oscillation varies both with load and circuit gain. The configuration most sensitive to oscillation is a unity-gain follower. See the Typical Performance Characteristics.

The load capacitance interacts with the op amp's output resistance to create an additional pole. If this pole frequency is sufficiently low, it will degrade the op amp's phase margin so that the amplifier is no longer stable at low gains. As shown in *Figure 10a*, the addition of a small resistor (50Ω–100Ω) in series with the op amp's output, and a capacitor (5 pF–10 pF) from inverting input to output pins, returns the phase margin to a safe value without interfering with lower-frequency circuit operation. Thus, larger values of capacitance can be tolerated without oscillation. Note that in all cases, the output will ring heavily when the load capacitance is near the threshold for oscillation.
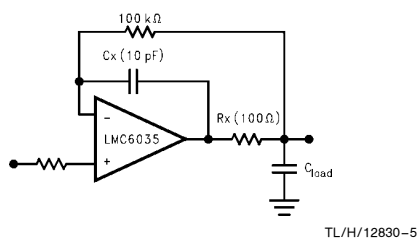
Capacitive load driving capability is enhanced by using a pull up resistor to V$^+$ *(Figure 10b)*. Typically a pull up resistor conducting 500 μA or more will significantly improve capacitive load responses. The value of the pull up resistor must be determined based on the current sinking capability of the amplifier with respect to the desired output swing. Open loop gain of the amplifier can also be affected by the pull up resistor (see Electrical Characteristics).
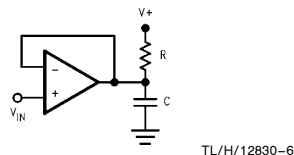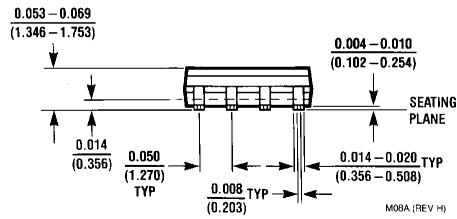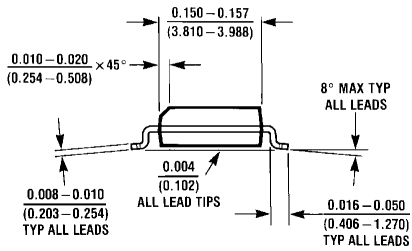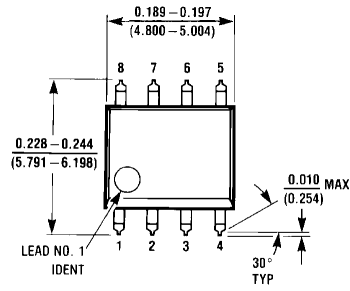

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FIGURE 10b. Compensating for Large Capacitive Loads with a Pull Up Resistor

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FIGURE 10a. Rx, Cx Improve Capacitive Load Tolerance

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Physical Dimensions inches (millimeters) unless otherwise noted

0.189 − 0.197
(4.800 − 5.004)

8 7 6 5

0.228 − 0.244
(5.791 − 6.198)

0.010 MAX
(0.254)

LEAD NO. 1
IDENT

1 2 3 4

30°
TYP

0.150 − 0.157
(3.810 − 3.988)

0.010 − 0.020 × 45°
(0.254 − 0.508)

8° MAX TYP
ALL LEADS

0.004
(0.102)
ALL LEAD TIPS

0.008 − 0.010
(0.203 − 0.254)
TYP ALL LEADS

0.016 − 0.050
(0.406 − 1.270)
TYP ALL LEADS

0.053 − 0.069
(1.346 − 1.753)

0.004 − 0.010
(0.102 − 0.254)

SEATING
PLANE

0.014
(0.356)

0.050
(1.270)
TYP

0.008 TYP
(0.203)

0.014 − 0.020 TYP
(0.356 − 0.508)

M08A (REV H)

8-Lead (0.150″ Wide) Molded
Small Outline Package, JEDEC
Order Number LMC6035IM or LMC6035IMX
NS Package Number M08A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

0.118±0.004
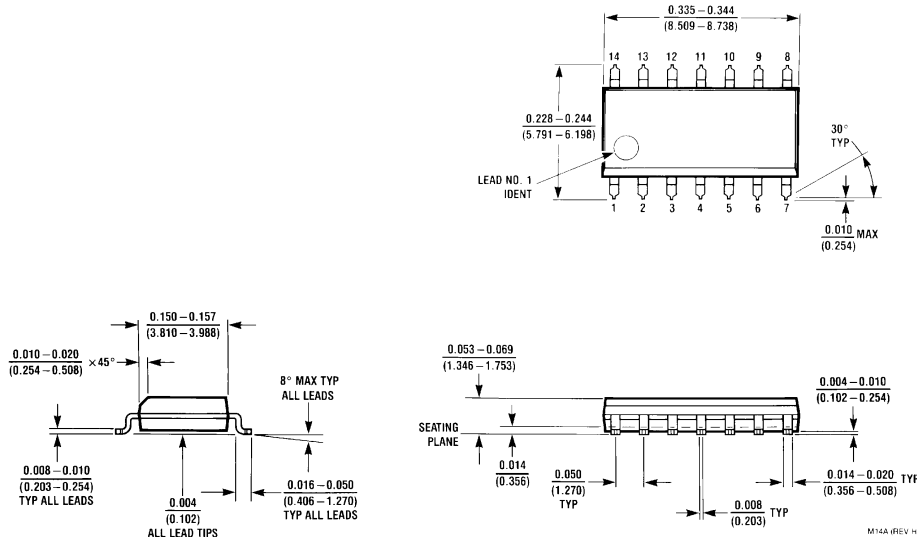[3±0.1]
-A-

8   5

0.193±0.004
[4.9±0.1]

0.118±0.004
[3±0.1]
-B-

PIN 1
IDENT

1   4

(0.0256) TYP
[0.65]

SYMM
C

(0.189)
[4.8]

(0.040) TYP
[1.02]

(0.016) TYP
[0.41]

(0.0256) TYP
[0.65]

LAND PATTERN RECOMMENDATION

0.030-0.037
[0.76-0.94]

-C-

△ | 0.002 [0.05] | C

0.002-0.006 TYP
[0.06-0.15]

0.012±0.002 TYP
[0.3±0.05]

(0.033)
[0.84]

⊕ | 0.002 [0.05] Ⓜ | AⓈ | BⓈ

R 0.005 TYP
[0.13]

R 0.005 TYP
[0.13]

GAGE
PLANE

(0.010)
[0.25]

0.021±0.005
[0.53±0.12]

0.0375
[0.953]

0° – 6° TYP

SEATING PLANE

0.007±0.002 TYP
[0.18±0.05]

MA08D (REV A)
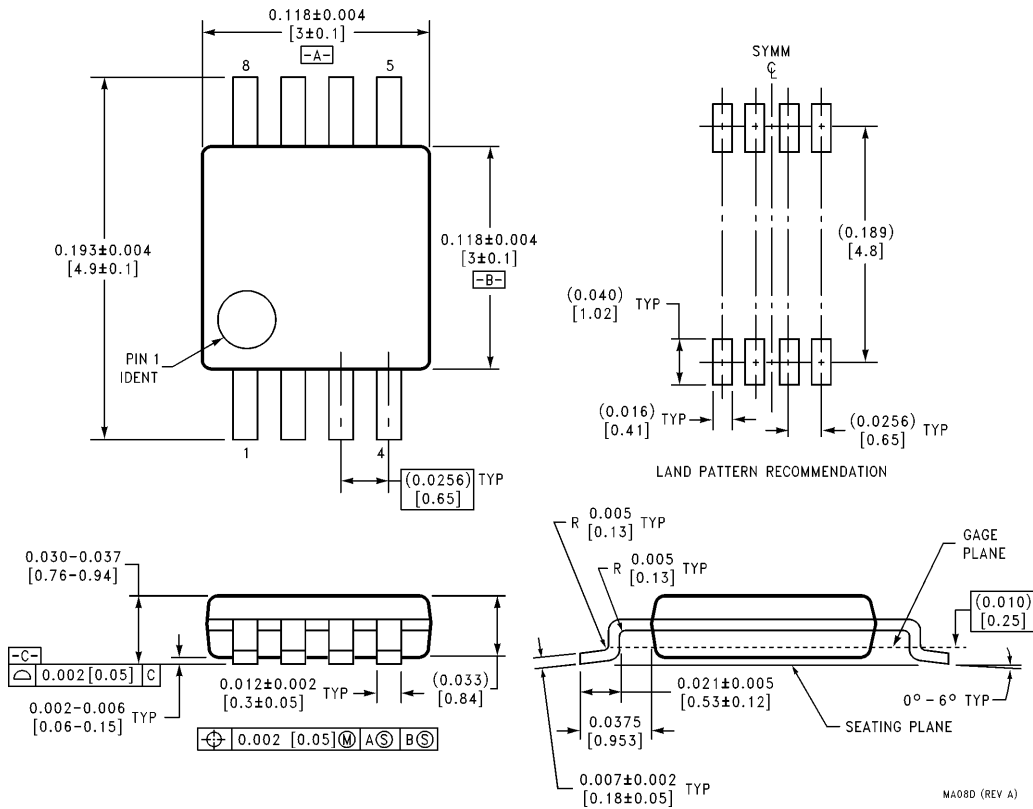
8-Lead (0.150″ Wide) Molded
Mini Small Outline Package, JEDEC
Order Number LMC6035IMM or LMC6035IMMX
NS Package Number MA08D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

0.335 − 0.344
(8.509 − 8.738)

14 13 12 11 10 9 8

0.228 − 0.244
(5.791 − 6.198)

LEAD NO. 1
IDENT

1 2 3 4 5 6 7

30°
TYP

0.010
(0.254) MAX

0.150 − 0.157
(3.810 − 3.988)

0.010 − 0.020
(0.254 − 0.508) × 45°

8° MAX TYP
ALL LEADS

0.008 − 0.010
(0.203 − 0.254)
TYP ALL LEADS

0.004
(0.102)
ALL LEAD TIPS

0.016 − 0.050
(0.406 − 1.270)
TYP ALL LEADS

0.053 − 0.069
(1.346 − 1.753)

SEATING
PLANE

0.014
(0.356)

0.050
(1.270)
TYP

0.008
(0.203) TYP

0.004 − 0.010
(0.102 − 0.254)

0.014 − 0.020
(0.356 − 0.508) TYP

M14A (REV H)

14-Lead (0.150″ Wide) Molded
Small Outline Package, JEDEC
Order Number LMC6036IM or LMC6036IMX
NS Package Number M14A

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